

# ON Semiconductor

## Is Now

# onsemi™

To learn more about onsemi™, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

---

**onsemi** and **onsemi** and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi** product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner. Other names and brands may be claimed as the property of others.



ON Semiconductor®

## FDD9410L-F085

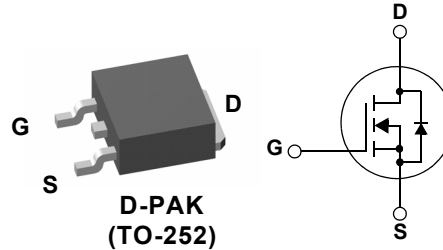
### N-Channel Logic Level PowerTrench® MOSFET 40 V, 50 A, 4.2 mΩ

#### Features

- Typical  $R_{DS(on)}$  = 3.3 mΩ at  $V_{GS} = 10V$ ,  $I_D = 50 A$
- Typical  $Q_{g(tot)}$  = 29 nC at  $V_{GS} = 10V$ ,  $I_D = 50 A$
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12V Systems



#### MOSFET Maximum Ratings $T_J = 25^\circ C$ unless otherwise noted.

| Symbol          | Parameter                                                | Ratings            | Units         |
|-----------------|----------------------------------------------------------|--------------------|---------------|
| $V_{DSS}$       | Drain-to-Source Voltage                                  | 40                 | V             |
| $V_{GS}$        | Gate-to-Source Voltage                                   | ±20                | V             |
| $I_D$           | Drain Current - Continuous ( $V_{GS}=10$ ) (Note 1)      | $T_C = 25^\circ C$ | 50            |
|                 | Pulsed Drain Current                                     | $T_C = 25^\circ C$ | See Figure 4  |
| $E_{AS}$        | Single Pulse Avalanche Energy (Note 2)                   | 24                 | mJ            |
| $P_D$           | Power Dissipation                                        | 75                 | W             |
|                 | Derate Above $25^\circ C$                                | 0.5                | W/ $^\circ C$ |
| $T_J, T_{STG}$  | Operating and Storage Temperature                        | -55 to + 175       | $^\circ C$    |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case                     | 2                  | $^\circ C/W$  |
| $R_{\theta JA}$ | Maximum Thermal Resistance, Junction to Ambient (Note 3) | 52                 | $^\circ C/W$  |

#### Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^\circ C$ ,  $L = 30\mu H$ ,  $I_{AS} = 40A$ ,  $V_{DD} = 40V$  during inductor charging and  $V_{DD} = 0V$  during time in avalanche.
- 3:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

#### Package Marking and Ordering Information

| Device Marking | Device        | Package       | Reel Size | Tape Width | Quantity  |
|----------------|---------------|---------------|-----------|------------|-----------|
| FDD9410L       | FDD9410L-F085 | D-PAK(TO-252) | 13"       | 16mm       | 2500units |

## Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|--------|-----------|-----------------|------|------|------|-------|
|--------|-----------|-----------------|------|------|------|-------|

### Off Characteristics

|               |                                   |                                                        |    |   |           |               |
|---------------|-----------------------------------|--------------------------------------------------------|----|---|-----------|---------------|
| $B_{V_{DSS}}$ | Drain-to-Source Breakdown Voltage | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$             | 40 | - | -         | V             |
| $I_{DSS}$     | Drain-to-Source Leakage Current   | $V_{DS} = 40\text{V}, T_J = 25^\circ\text{C}$          | -  | - | 1         | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{V}, T_J = 175^\circ\text{C}$ (Note 4) | -  | - | 1         | mA            |
| $I_{GSS}$     | Gate-to-Source Leakage Current    | $V_{GS} = \pm 20\text{V}$                              | -  | - | $\pm 100$ | nA            |

### On Characteristics

|              |                                  |                                                         |     |     |     |            |
|--------------|----------------------------------|---------------------------------------------------------|-----|-----|-----|------------|
| $V_{GS(th)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250\mu\text{A}$                 | 1.0 | 1.8 | 3.0 | V          |
| $R_{DS(on)}$ | Drain to Source On Resistance    | $I_D = 50\text{A}, V_{GS} = 4.5\text{V}$                | -   | 5.0 | 6.5 | m $\Omega$ |
|              |                                  | $I_D = 50\text{A}, T_J = 25^\circ\text{C}$              | -   | 3.3 | 4.2 | m $\Omega$ |
|              |                                  | $V_{GS} = 10\text{V}, T_J = 175^\circ\text{C}$ (Note 4) | -   | 6.0 | 7.6 | m $\Omega$ |

### Dynamic Characteristics

|              |                               |                                                            |   |      |    |          |
|--------------|-------------------------------|------------------------------------------------------------|---|------|----|----------|
| $C_{iss}$    | Input Capacitance             | $V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$ | - | 1960 | -  | pF       |
| $C_{oss}$    | Output Capacitance            |                                                            | - | 615  | -  | pF       |
| $C_{riss}$   | Reverse Transfer Capacitance  |                                                            | - | 41   | -  | pF       |
| $R_g$        | Gate Resistance               | $f = 1\text{MHz}$                                          | - | 1.9  | -  | $\Omega$ |
| $Q_{g(ToT)}$ | Total Gate Charge             | $V_{GS} = 0$ to 10V                                        | - | 29   | 43 | nC       |
| $Q_{g(th)}$  | Threshold Gate Charge         | $V_{GS} = 0$ to 2V                                         |   |      |    |          |
| $Q_{gs}$     | Gate-to-Source Gate Charge    | $V_{DD} = 32\text{V}, I_D = 50\text{A}$                    | - | 6    | -  | nC       |
| $Q_{gd}$     | Gate-to-Drain "Miller" Charge |                                                            | - | 5    | -  | nC       |

### Switching Characteristics

|              |                |                                                                                 |   |    |    |    |
|--------------|----------------|---------------------------------------------------------------------------------|---|----|----|----|
| $t_{on}$     | Turn-On Time   | $V_{DD} = 20\text{V}, I_D = 50\text{A}, V_{GS} = 10\text{V}, R_{GEN} = 6\Omega$ | - | -  | 22 | ns |
| $t_{d(on)}$  | Turn-On Delay  |                                                                                 | - | 8  | -  | ns |
| $t_r$        | Rise Time      |                                                                                 | - | 7  | -  | ns |
| $t_{d(off)}$ | Turn-Off Delay |                                                                                 | - | 25 | -  | ns |
| $t_f$        | Fall Time      |                                                                                 | - | 5  | -  | ns |
| $t_{off}$    | Turn-Off Time  |                                                                                 | - | -  | 45 | ns |

### Drain-Source Diode Characteristics

|          |                               |                                                          |   |    |      |    |
|----------|-------------------------------|----------------------------------------------------------|---|----|------|----|
| $V_{SD}$ | Source-to-Drain Diode Voltage | $I_{SD} = 50\text{A}, V_{GS} = 0\text{V}$                | - | -  | 1.25 | V  |
|          |                               | $I_{SD} = 25\text{A}, V_{GS} = 0\text{V}$                | - | -  | 1.2  | V  |
| $t_{rr}$ | Reverse-Recovery Time         | $I_F = 50\text{A}, dI_{SD}/dt = 100\text{A}/\mu\text{s}$ | - | 47 | 71   | ns |
| $Q_{rr}$ | Reverse-Recovery Charge       | $V_{DD} = 32\text{V}$                                    | - | 36 | 71   | nC |

#### Note:

4: The maximum value is specified by design at  $T_J = 175^\circ\text{C}$ . Product is not tested to this condition in production.

## Typical Characteristics

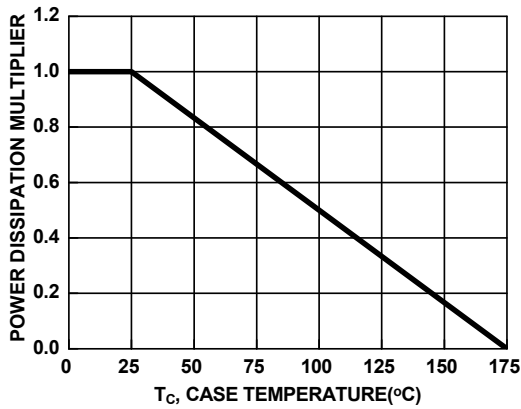


Figure 1. Normalized Power Dissipation vs. Case Temperature

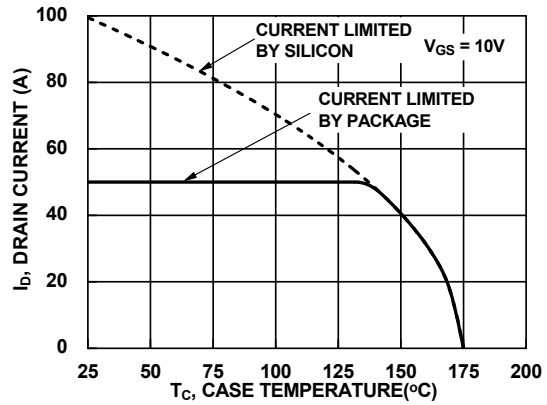


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

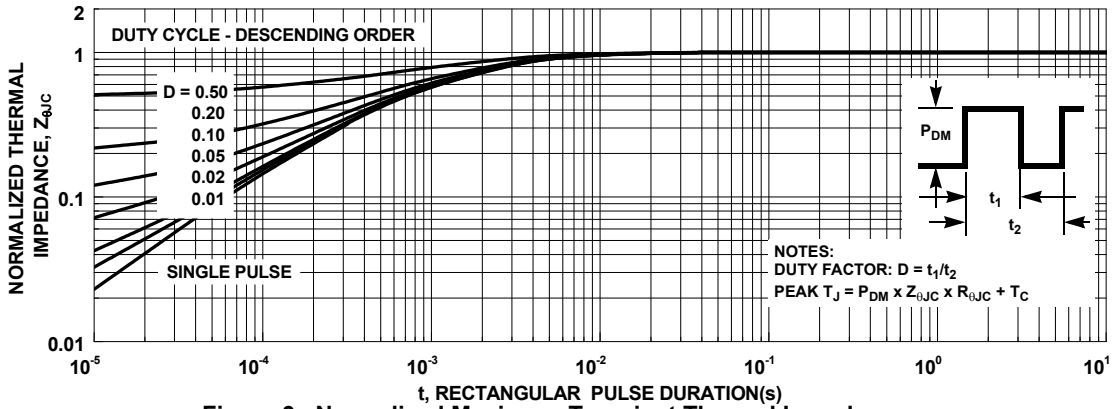


Figure 3. Normalized Maximum Transient Thermal Impedance

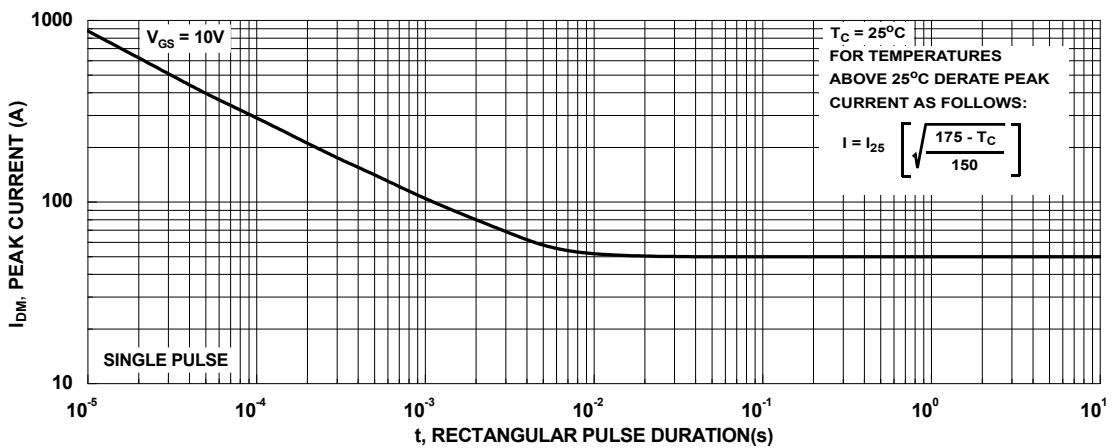


Figure 4. Peak Current Capability

### Typical Characteristics

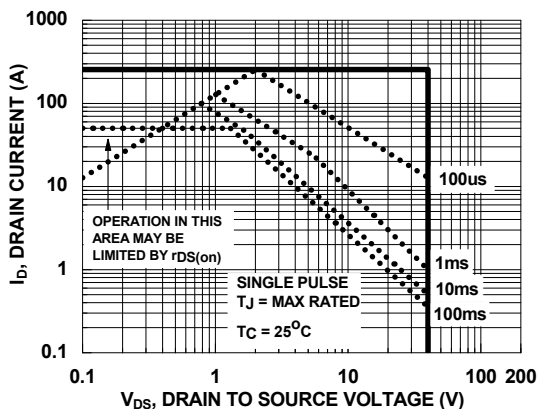
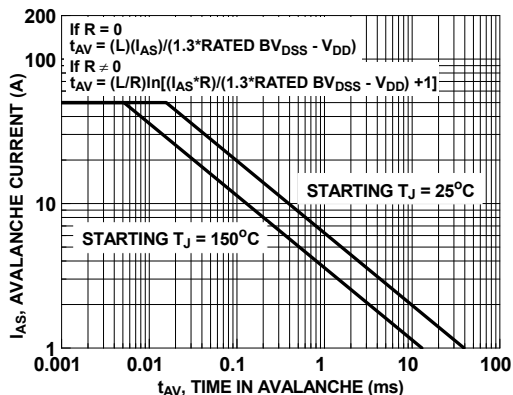


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

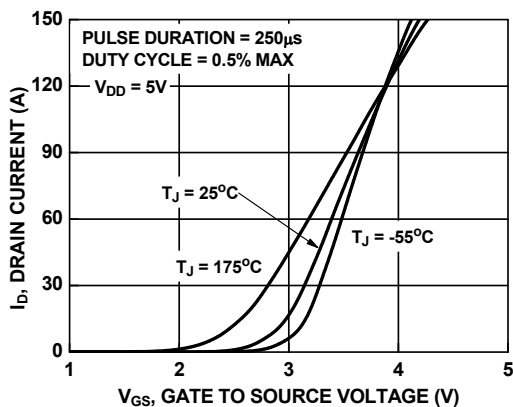


Figure 7. Transfer Characteristics

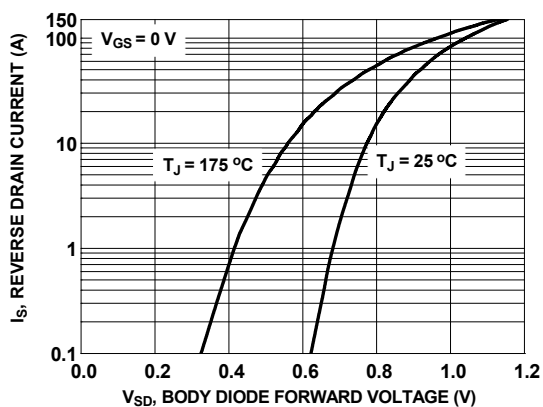


Figure 8. Forward Diode Characteristics

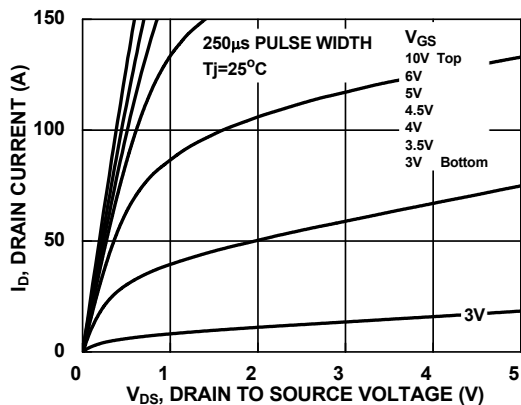


Figure 9. Saturation Characteristics

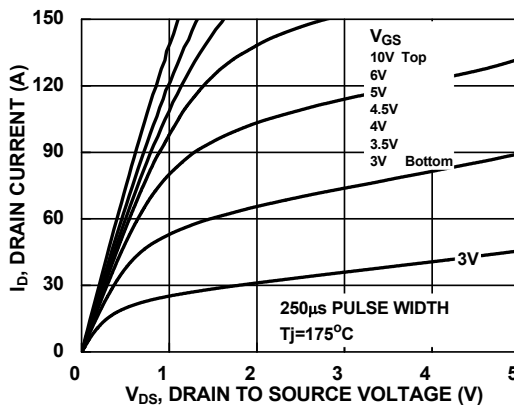


Figure 10. Saturation Characteristics

### Typical Characteristics

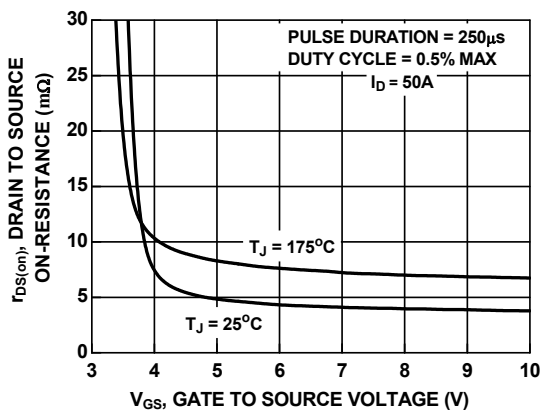


Figure 11.  $R_{DS(on)}$  vs. Gate Voltage

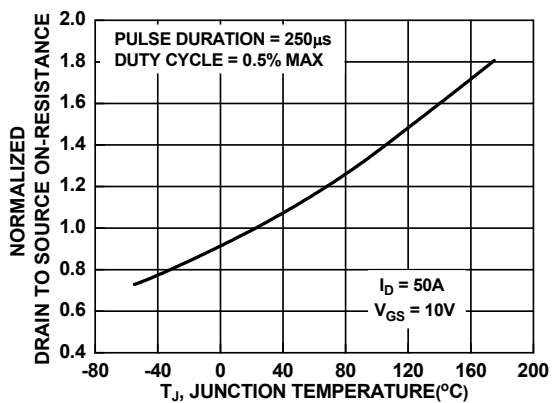


Figure 12. Normalized  $R_{DS(on)}$  vs. Junction Temperature

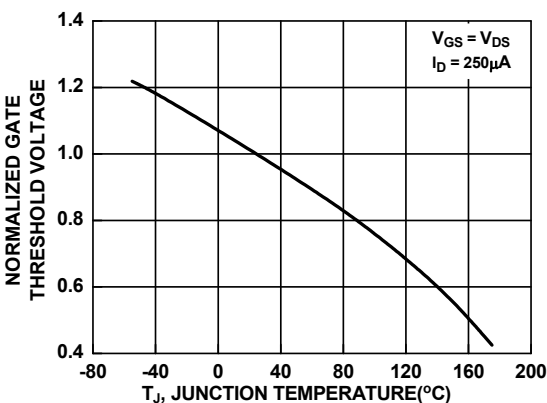


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

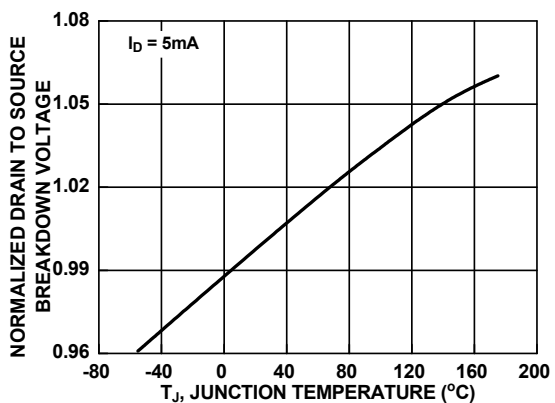


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

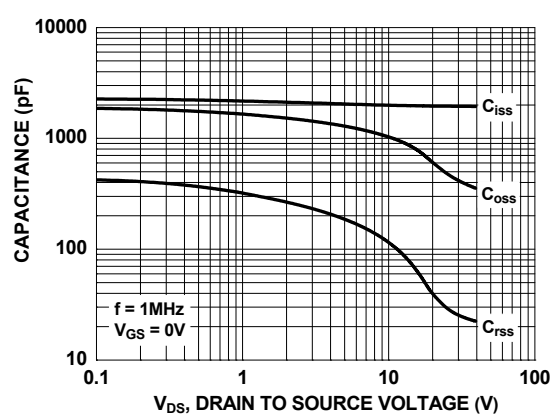


Figure 15. Capacitance vs. Drain to Source Voltage

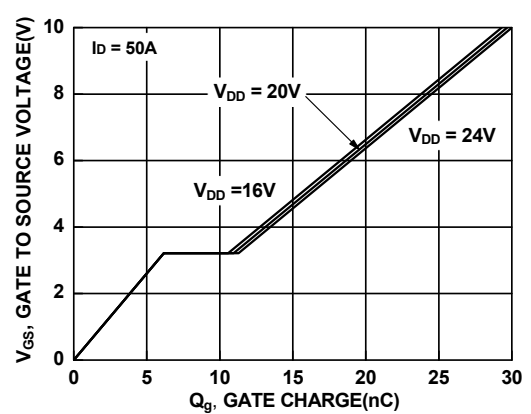


Figure 16. Gate Charge vs. Gate to Source Voltage

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [MOSFET](#) category:*

*Click to view products by [ON Semiconductor](#) manufacturer:*

Other Similar products are found below :

[614233C](#) [648584F](#) [IRFD120](#) [JANTX2N5237](#) [FCA20N60\\_F109](#) [FDZ595PZ](#) [2SK2545\(Q,T\)](#) [405094E](#) [423220D](#) [TPCC8103,L1Q\(CM](#)  
[MIC4420CM-TR](#) [VN1206L](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#) [BUK954R8-60E](#)  
[NTE6400](#) [SQJ402EP-T1-GE3](#) [2SK2614\(TE16L1,Q\)](#) [2N7002KW-FAI](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#)  
[FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE222](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#)  
[NTE2967](#) [NTE2969](#) [NTE2976](#) [NTE455](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#)  
[SSM6P69NU,LF](#) [DMP22D4UFO-7B](#)